Declaration For U.S. Patent Application

As a below named inventor, I hereby declare that:

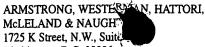
My residence, post office address and co	itizenship are as stated below next to my name.
I believe I am the original of	are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled the specification of which is attached hereto unless the following is checked: was filed on _ __as United States Application Number or PCT International Application Number_ (if applicable). and was amended on I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56. I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) - (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a fil-Ü Patent Appln. 2000-224924 (List prior foreign JAPAN 26/July/2000 Priority Claimed (Number) applications. (Country) Yes No (Day/Month/Year Filed) See note A (Number) on back of (Country) ☐ Yes ☐ No (Day/Month/Year Filed) this page) (Number) (Country) ☐ Yes ☐ No (Day/Month/Year Filed) (Number) (Country) 🔾 Yes 🗘 No (See note B on back of this page) (Day/Month/Year Filed) ☐ See attached list for additional prior foreign applications I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below. (Application Number) (Filing Date) (Application Number) I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application (List Prior U.S. (Application Serial Number) Applications) (Filing Date) (Status) (patented, pending, abandoned) (Application Serial Number) (Filing Date) (Status) (patented, pending, abandoned)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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